

Product Features

- Compliant with IEEE Std 802.3-2005
10G Ethernet 10GBase-LR/LW
- Electrical interface specifications per SFF-8431
- Management interface specifications per SFF-8431 and SFF-8472
- SFP+ MSA package with duplex LC connector
- Uncooled 1310nm DFB Laser
- Up to 10.3Gb/s bi-directional data links
- Single +3.3V power supply
- Class 1 laser safety certified
- Operating temperature Options
 - (Commercial) 0°C to +70°C
 - (Industrial) -40°C to +85°C
- Up to 10km on 9/125µm SMF
- RoHS Compliant



Applications

- 10G Ethernet 10GBASE-LR/LW
- 10G Fiber Channel 1200-SM-LL-L

Descriptions

LX4002xDR SFP+ transceivers, according to Enhanced 8.5 and 10 Gigabit Small Form Factor Pluggable “SFP+” Multi-Sourcing Agreement (MSA) SFF-8431 and SFF-8472, revision 10.4, are designed for 10G Ethernet serial optical data communication up to 10km on single mode fiber. They are compliant with IEEE Std 802.3-2005 10Gb Ethernet 10GBase-LR/LW and 10G Fiber Channel 1200-SM-LL-L.

LX4002xDR offer commercial and industrial operating temperature options.

Ordering Information

Table 1. Ordering Information

Part Number	Transmitter	Output Power	Receiver	Sensitivity	Reach	Temp	DDM	RoHS
LX4002CDR	1310nm DFB	-8.2 ~ +0.5dBm	PIN	< -14.4dBm	10km	0 ~ 70 °C	Available	Compliant
LX4002IDR	1310nm DFB	-8.2 ~ +0.5dBm	PIN	< -14.4dBm	10km	-40 ~ 85 °C	Available	Compliant

Pin Description

Table 2. Pin Description

Pin	Name	Function/Description	Notes
1	VeeT	Transmitter Ground	1
2	TX_Fault	Transmitter Fault (LVTTTL-O) - High indicates a fault condition	2
3	TX_Disable	Transmitter Disable (LVTTTL-I) – High or open disables the transmitter	3
4	SDA	Two wire serial interface Data Line (LVCMOS-I/O) (MOD-DEF2)	4
5	SCL	Two wire serial interface Clock Line (LVCMOS-I/O) (MOD-DEF1)	4
6	MOD_ABS	Module Absent (Output), connected to VeeT or VeeR in the module	5
7	RS0	Rate Select 0 – Not used, Presents high input impedance	-
8	RX_LOS	Receiver Loss of Signal (LVTTTL-O)	2
9	RS1	Rate Select 1 – Not used, Presents high input impedance	-
10	VeeR	Receiver Ground	1
11	VeeR	Receiver Ground	1
12	RD-	Inverse Received Data out (CML-O)	-
13	RD+	Received Data out (CML-O)	-
14	VeeR	Receiver Ground	-
15	VccR	Receiver Power - +3.3V	-
16	VccT	Transmitter Power - +3.3 V	-
17	VeeT	Transmitter Ground	1
18	TD+	Transmitter Data In (CML-I)	-
19	TD-	Inverse Transmitter Data In (CML-I)	-
20	VeeT	Transmitter Ground	1

Notes:

1. The module signal grounds are isolated from the module case.
2. This is an open collector/drain output that on the host board requires a 4.7KΩ to 10KΩ pull-up resistor to VccHost.
3. This input is internally biased high with a 4.7KΩ to 10KΩ pull-up resistor to VccT.
4. Two-Wire Serial interface clock and data lines require an external pull-up resistor dependent on the capacitance load.
5. This is a ground return that on the host board requires a 4.7KΩ to 10KΩ pull-up resistor to VccHost.

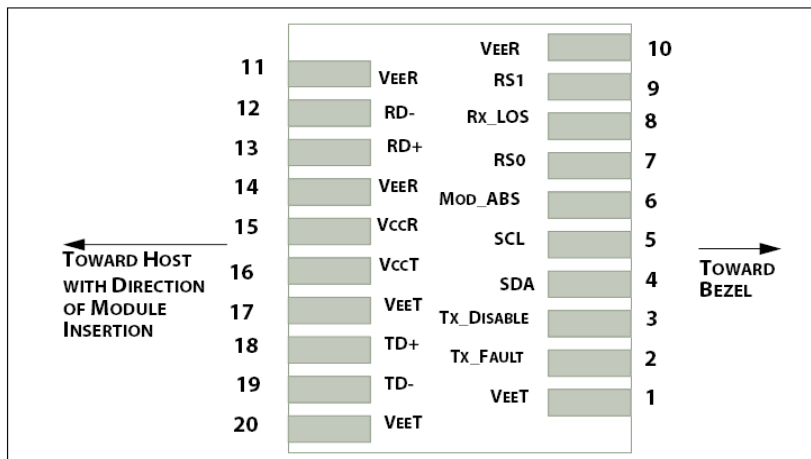


Figure 1. Host PCB SFP+ pad assignment top view

Absolute Maximum Ratings

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect device reliability.

Table 3. Absolute Maximum Ratings

Parameter	Symbol	Minimum	Maximum	Unit
Storage Temperature	Ts	-40	85	°C
Relative Humidity	RH	5	95	%
Supply Voltage	Vcc	-0.5	4.0	V

Recommended Operating Conditions

Table 4. Recommended Operating Conditions

Parameter	Symbol	Min	Typ	Max	Unit	
Operating Temperature	LX4002CDR	Tc	0	25	70	°C
	LX4002IDR	Tc	-40	25	85	°C
Supply Voltage	Vcc	3.135	3.3	3.465	V	
Data Rate	-	-	10.3125	-	Gb/s	

Transceiver Electrical Characteristics

Table 5. Transceiver Electrical Characteristics

Parameter	Symbol	Minimum	Typical	Maximum	Unit	Notes	
Module Supply Current	Icc	-	-	300	mA	-	
Power Dissipation	Pd	-	-	1000	mW	-	
Transmitter							
Input Differential Impedance	ZIN	-	100	-	Ω	-	
Differential Data Input Swing	VIN, P-P	180	-	700	mVP-P	-	
TX_FAULT	Transmitter Fault	VOH	2.0	-	VcCHOST	V	-
	Normal Operation	VOL	0	-	0.8	V	-
TX_DISABLE	Transmitter Disable	VIH	2.0	-	VcCHOST	V	-
	Transmitter Enable	VIL	0	-	0.8	V	-
Receiver							
Output Differential Impedance	Zo	-	100	-	Ω	-	
Differential Data Output Swing	VOUT, P-P	300	-	850	mVP-P	1	

Data Output Rise Time, Fall Time	t_r, t_f	28	-	-	ps	2	
RX_LOS	Loss of signal (LOS)	V_{OH}	2.0	-	V_{CCHOST}	V	3
	Normal Operation	V_{OL}	0	-	0.8	V	3

Notes:

- Internally AC coupled, but requires a external 100Ω differential load termination.
- 20 – 80 %.
- LOS is an open collector output. Should be pulled up with 4.7kΩ on the host board.

Transmitter Optical Characteristics

Table 6. Transmitter Optical Characteristics

Parameter	Symbol	Minimum	Typical	Maximum	Unit	Notes
Launch Optical Power	P_o	-8.2	-	+0.5	dBm	1
Center Wavelength Range	λ_c	1260	1310	1355	nm	-
Extinction Ratio	EX	3.5	-	-	dB	2
Optical Modulation Amplitude	OMA	-5.2	-	-	dBm	
Spectral Width (-20dB)	$\Delta\lambda$	-	-	1	nm	-
Side Mode Suppression Ratio	SMSR	30	-	-	dB	-
Transmitter and Dispersion Penalty	TDP	-	-	3.2	dB	-
Optical Return Loss Tolerance	ORLT	-	-	12	dB	-
Pout @TX-Disable Asserted	P_{off}	-	-	-30	dBm	1
Eye Diagram	IEEE Std 802.3-2005 10Gb Ethernet 10GBASE-LR compatible					

Notes:

- The optical power is launched into 9/125μm SMF.
- Measured with a PRBS 2³¹-1 test pattern @10.3125Gbps.

Receiver Optical Characteristics

Table 7. Receiver Optical Characteristics

Parameter	Symbol	Minimum	Typical	Maximum	Unit	Notes
Center Wavelength	λ_c	1260	1310	1355	nm	-
Receiver Sensitivity (P_{avg})	S	-	-	-14.4	dBm	1
Receiver Sensitivity (OMA)	S_{OMA}	-	-	-12.6	dBm	1
Receiver Overload (P_{avg})	P_{OL}	0.5	-	-	dBm	1
Stressed Sensitivity (OMA)	-	-	-	-10.3	dBm	2
Optical Return Loss	ORL	12	-	-	dB	-
LOS De-Assert	LOS_D	-	-	-16	dBm	-
LOS Assert	LOS_A	-30	-	-	dBm	-
LOS Hysteresis	-	0.5	-	-	dB	-

Notes:

- Measured with PRBS 2³¹-1 test pattern, 10.3125Gb/s, BER<10⁻¹².
- Comply with IEEE 802.3-2005.

Recommended Host Board Power Supply Filter Network

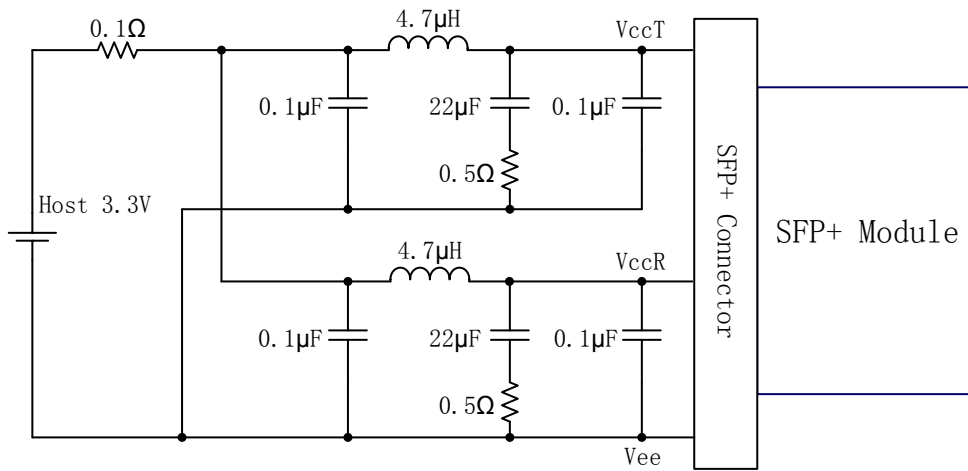


Figure 2. Recommended Host Board Power Supply Filter Network

Recommended Application Interface Block Diagram

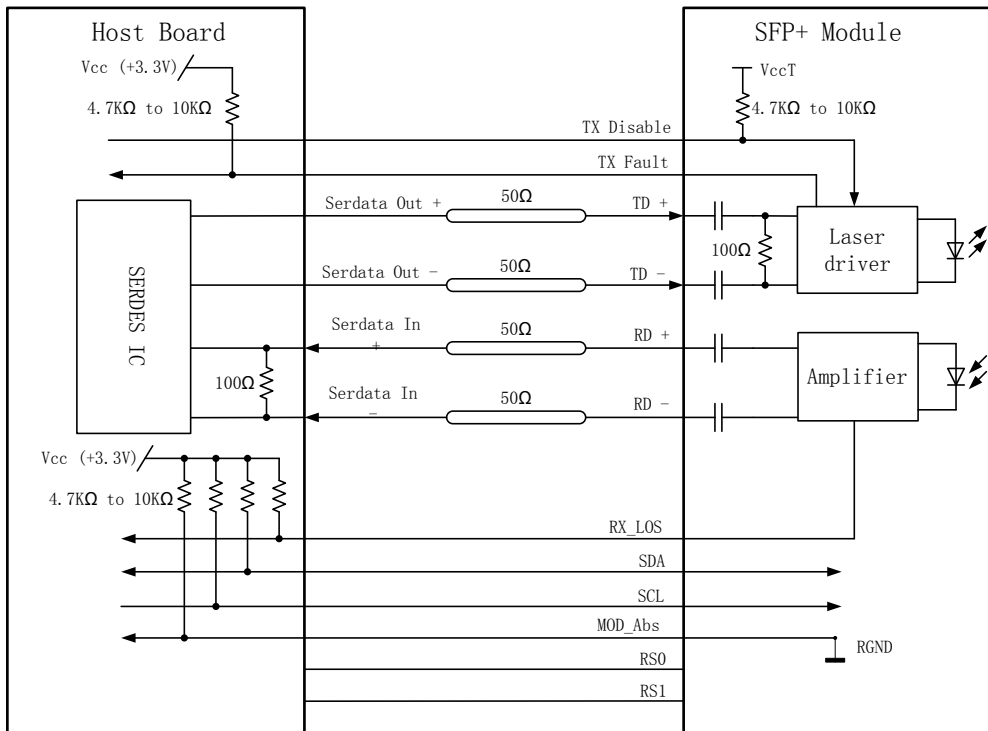


Figure 3. Recommended Application Interface Block Diagram

Mechanical specifications

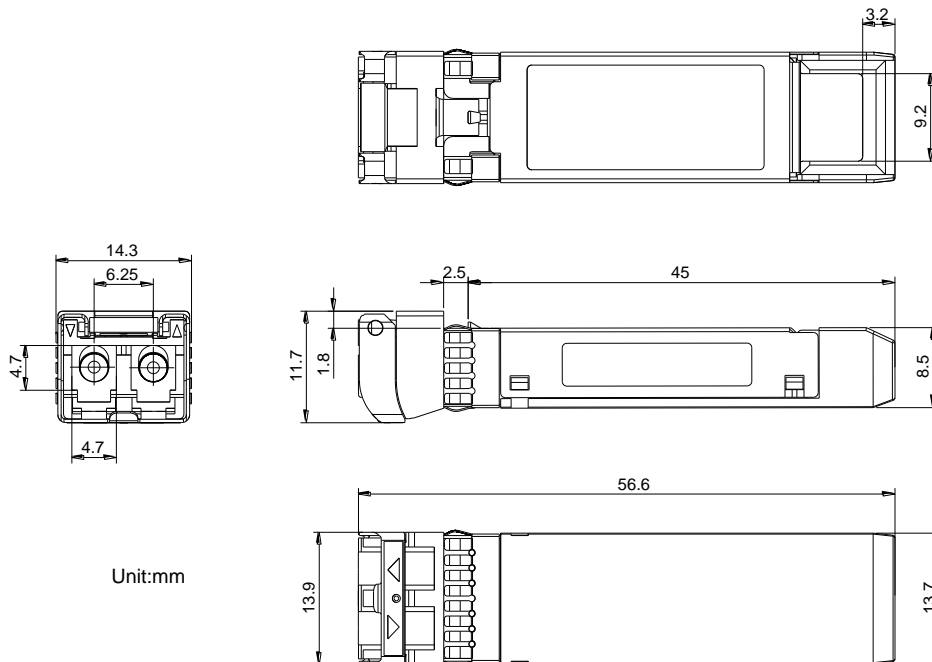


Figure 4. Outline Drawing

PCB layout recommendation

- Notes:
1. Datum and basic dimensions established by customer
 2. Pads and vias are chassis ground, 11 places
 3. Thru holes, plating optional

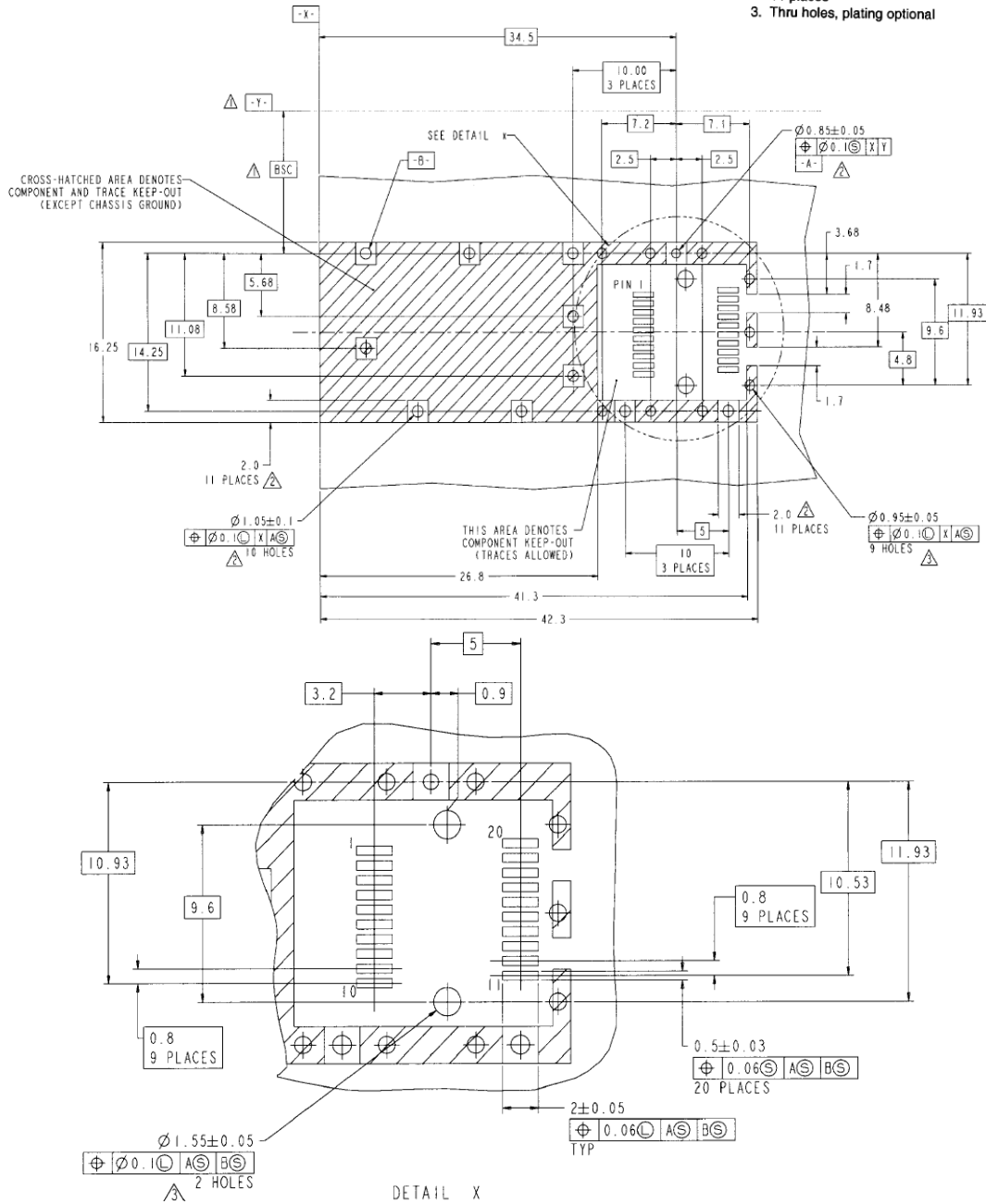


Figure 5. PCB layout recommendation

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